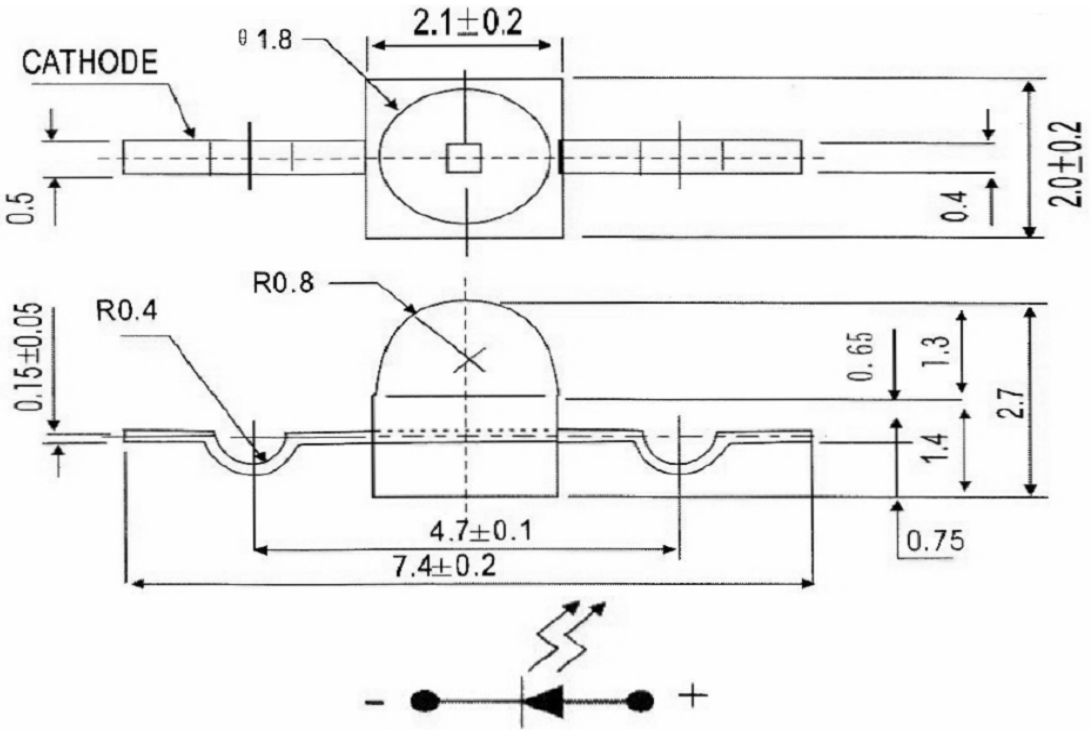
Applications

- Interior automotive lighting
- Optical indicators
- Communication Products
- Backlighting
- Toys

Technical Drawing



Recommended Soldering Pattern

Notes :

All dimensions in mm tolerance is
± 0.1mm unless otherwise noted.

Round Subminiature Yoke Lead (Square Base) LED

Blue Green

Part No.: **M11J6002**

Customer:

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Absolute Maximum Ratings

Ta=25°C

Item	*Symbol*	*InGaN / SiC*	*Unit*
Power Dissipation	P_D	---	mW
DC Forward Current	I_F	20	mA
Plused Forward Current	I_{FP}*	---	mA
Reverse Voltage	V_R	---	V
Operating Temperature	T_{OP}	---	°C
Storage Temperature	T_{ST}	-55 to 100	°C

* 0.1 msec pulse, 10% duty cycle

Electrcal / Optical Characteristics

I_F=20mA Ta=25°C

Ermitting Color	Blue Green		
Material	InGaN / SiC		
Forward Voltage	typ.	3.5	V_F
	max.	4.3	V_F
Wavelength typ.	λD	505	nm
	λP	---	nm
	Δλ	---	nm
Color Temperature	min.	---	K
	max.	---	K
Luminous Intensity *	min.	407	mcd
	typ.	703	mcd
Reverse Current	max.	---	μA
Viewing Angle	2Θ1/2	25	

* Per NIST standards

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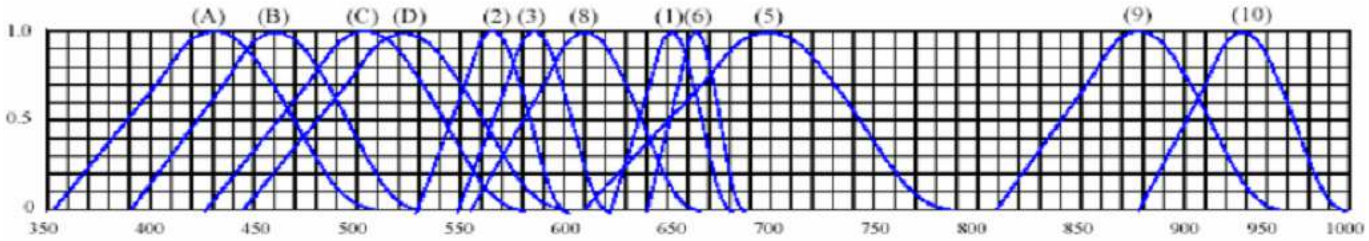
Curve



Wavelength (nm)

Relative Intensity vs Wavelength

(1)	**GaAsP / GaAs 655nm Red**	**(9)**	**GaAlAs 880nm**
(2)	**GaP 568nm Yellow Green**	**(10)**	**GaAs & GaAlAs 940nm**
(3)	**GaAsP / GaP 585nm Yellow**	**(A)**	**GaN 430nm Blue**
(4)	**GaAsP / GaP 635nm Orange & Red**	**(B)**	**InGaN 470nm Blue**
(5)	**GaP 700nm Red**	**(C)**	**InGaN 502nm Green**
(6)	**GaAlAs / GaAs 660nm Red**	**(D)**	**InGaN 523nm Green**
(8)	**GaAsP / GaP 610nm Red**		

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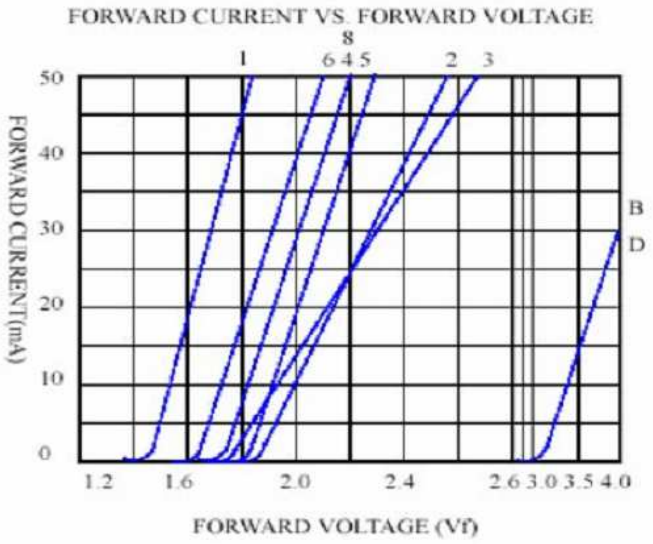
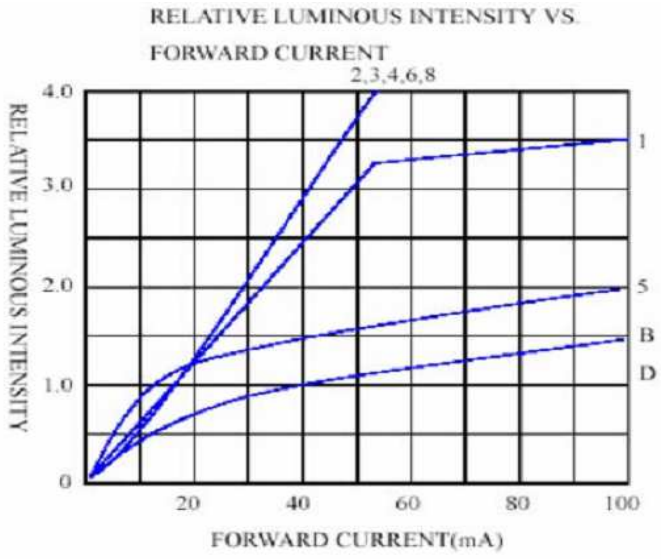
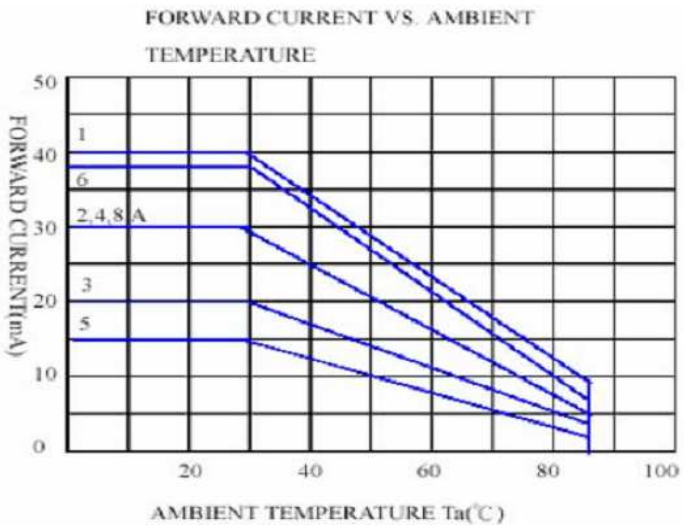
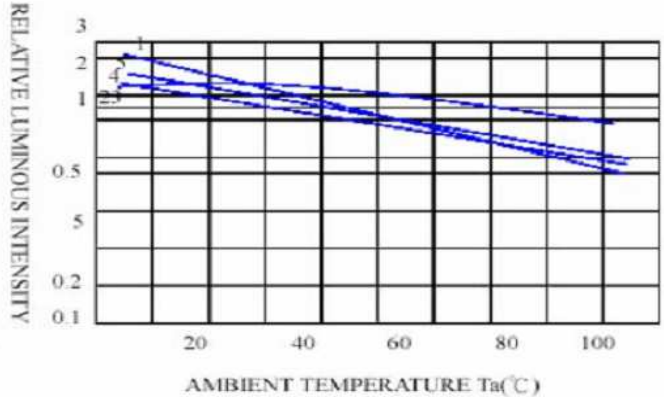
Curve









Round Subminiature Yoke Lead (Square Base) LED

Blue Green

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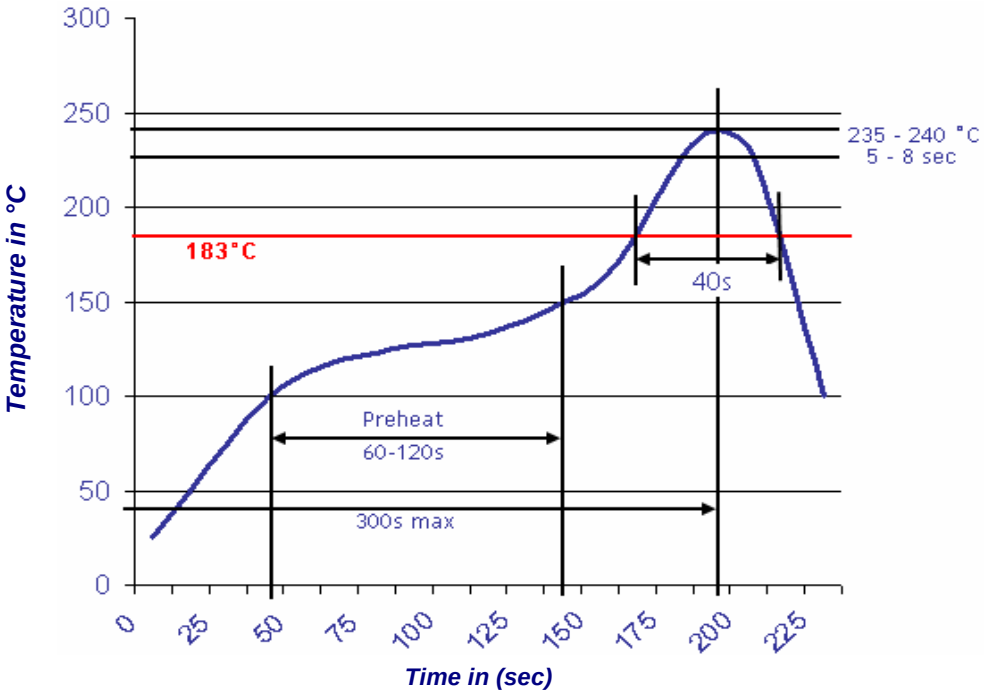
Solder Condition

Lead Free Solder

Classification Reflow Profile (JEDEC J-STD-020C)



Round Subminiature Yoke Lead (Square Base) LED

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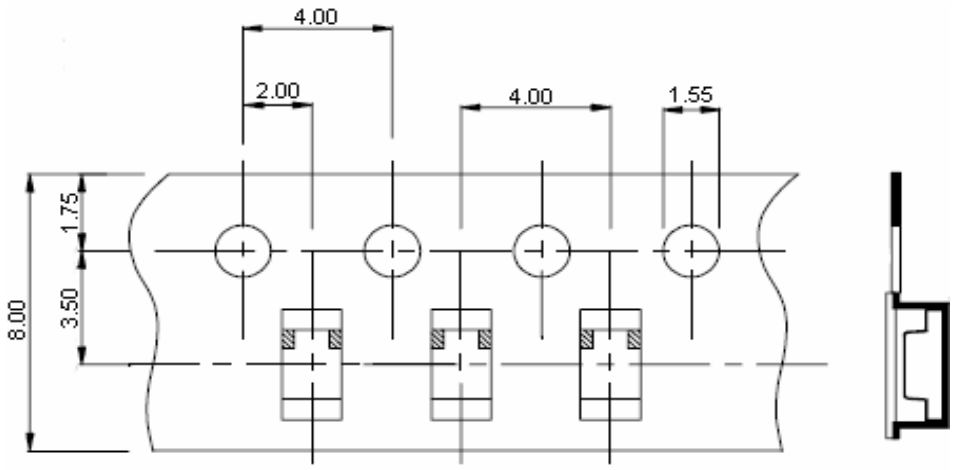
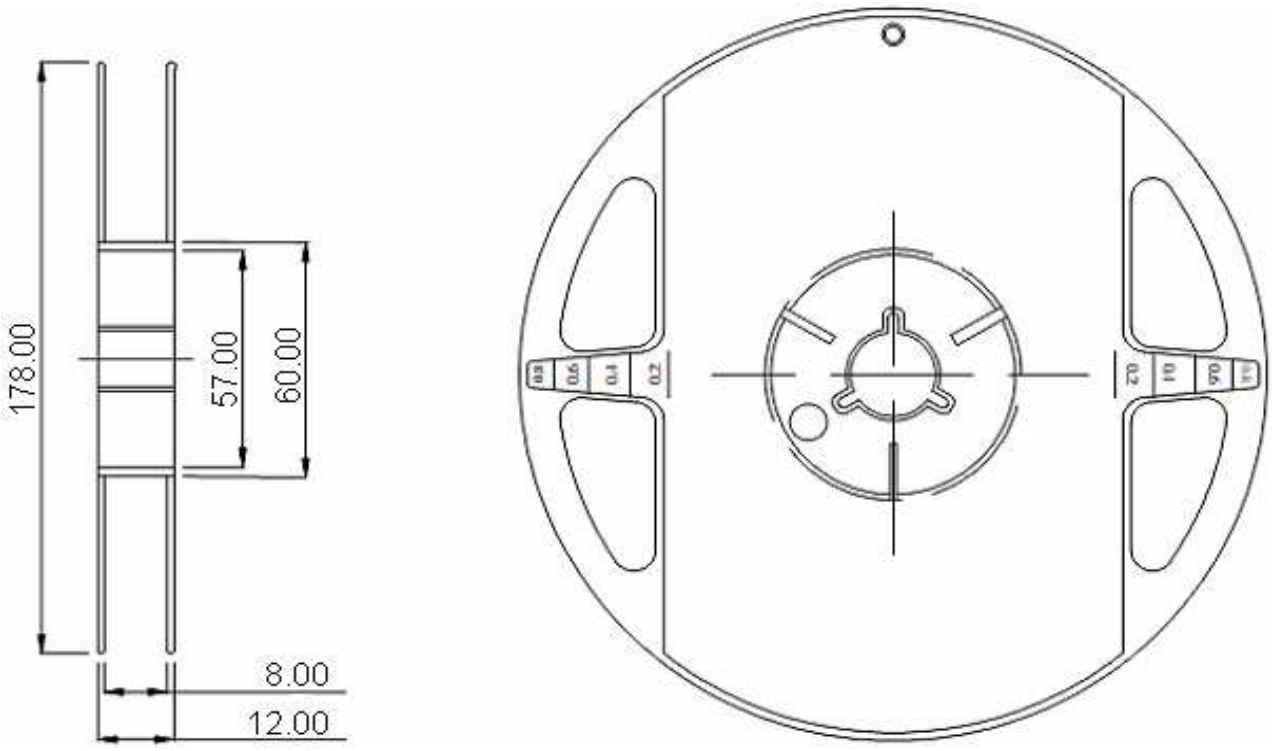
Packing Specifications



Reel Specifications



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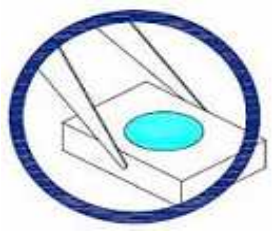
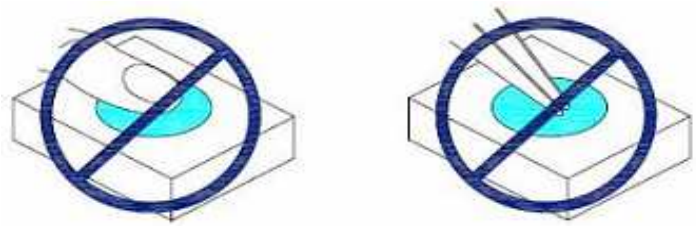
Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although ist characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of th LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools



2. Do not directly touch or handle the silicone lens surfance. It may damage the internal circuitry.



3. Do not stack together assembled PCBs containing exposed LEDs. Outside impact may scratch the silicone lens or damage the internal circuitry.

					Round Subminiature Yoke Lead (Square Base) LED ***Blue Green***		
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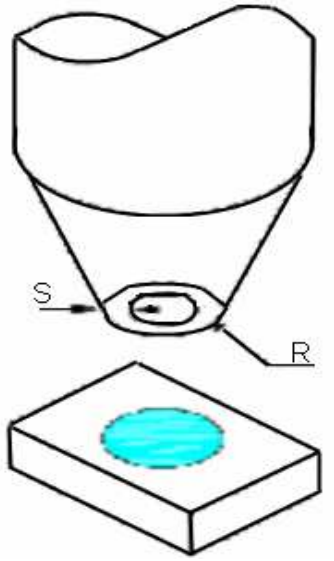
4. The outer diameter of the TOP LED pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible.

5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.

6. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



Round Subminiature Yoke Lead (Square Base) LED
Blue Green

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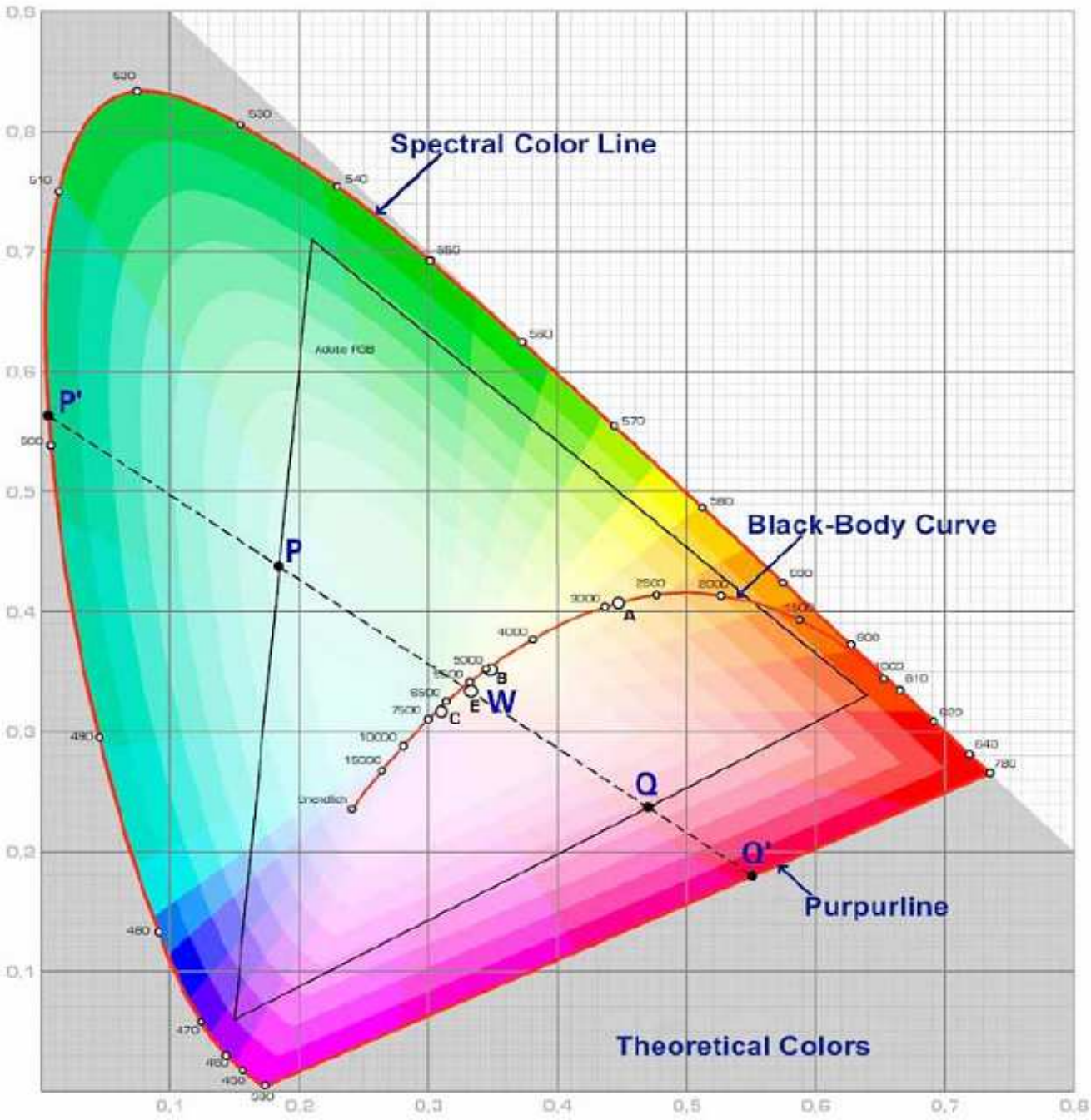
Color table curve



Round Subminiature Yoke Lead (Square Base) LED	
Blue Green	
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